SDIA6028 TYPE

FEATURE

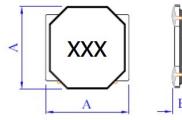
1. Low profile (Height: 2.80mm Max)

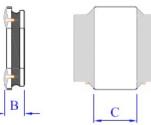
Applications

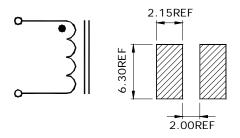
1. Digital camera, PDA and others

• Shape and Dimension

Schematics and Land Patterns(mm)







 $A=6.00\pm0.40$ m/m; B=2.80m/m MAX; C=2.70m/m TYP.;

Specification

Part Number	L(uH)	Marking	DCR(mΩMAX)	Isat(A)	Irms(A)
SDIA6028-1R0N	1.0±30%	1R0	17.0	7.60	5.20
SDIA6028-1R5N	1.5±30%	1R5	20.8	6.30	4.80
SDIA6028-2R2N	2.2±30%	2R2	33.8	5.40	4.00
SDIA6028-2R7N	2.7±30%	2R7	35.0	4.90	3.70
SDIA6028-3R3N	3.3±30%	3R3	36.4	4.30	3.50
SDIA6028-4R7N	4.7±30%	4R7	49.4	3.70	3.20
SDIA6028-6R0N	6.0±30%	6R0	58.5	3.30	2.80
SDIA6028-6R8N	6.8±30%	6R8	65.0	3.10	2.70
SDIA6028-100M	10±20%	100	84.5	2.50	2.30
SDIA6028-150M	15±20%	150	123.5	2.00	1.80
SDIA6028-220M	22±20%	220	175.5	1.60	1.50
SDIA6028-330M	33±20%	330	360.0	1.30	1.40
SDIA6028-470M	47±20%	470	416.0	1.10	1.00
SDIA6028-680M	68±20%	680	546.0	0.98	0.90
SDIA6028-101M	100±20%	101	780.0	0.82	0.80

FENG-JUI TECHNOLOGY CO., LTD

SMD POWER INDUCTOR-RoHS

Note1. Measurement frequency of Inductance value: at 100KHz

Note2. Measurement ambient temperature of L, DCR and IDC : at 25 $^{\circ}\!\mathbb{C}$

Note3. Inductance Tolerance: N: ±30%; M: ±20%

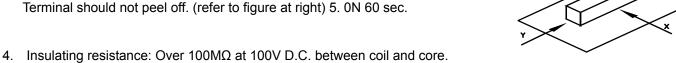
Note4. Isat : $\triangle L/L \le 30\%$ (This indicates the value of current when the inductances is 30% lower than its initial value at D.C. superimposition)

Note5. Irms:D.C. current when at $\Delta t=40^{\circ}$ C (typ.).(Ta=25 $^{\circ}$ C)

Note6. Packing: reel; Quantity: 1500 ea

GENERAL CHARACTERISTICS

- Operating temperature range: -40 TO + 105°C (Includes temperature when the coil is heated)
- 2. External appearance: On visual inspection, the coil has no external defects.
- Terminal strength: After soldering. Between copper plate and terminals of coil. Push in two directions of X.Ywithstanding at below conditions.



- Dielectric strength: No dielectric breakdown at 100V D.C. for 1 minute between coil and core.
- Temperature characteristics: Inductance coefficient (0~2,000)x10-6/°C (-25~+80°C).
- Humidity characteristics(Moisture Resistance): Inductance deviation within ±5%, after 96 hours in 90~95% relative humidity at 40 ±2°C and 1 hour drying under normal condition.
- 8. Vibration resistance: Inductance deviation within ±5%, after vibration for 1 hour. In each of three orientations at sweep vibration (10~55~10 Hz) with 1.5mm P-P amplitudes.
- 9. Shock resistance: Inductance deviation within ±5%, after being dropped once with 981m/s2 (100G) shock attitude upon a rubber block method shock testing machine, in three different orientations.
- 10. Resistance to Soldering Heat: 260℃, 10 seconds(See attached recommend reflow)
- 11. Storage environment: Storage condition: Temperature Range: 10°C ~ 35°C (Generally: 21°C ~ 31°C) , Humidity Range: 50% ~ 80% RH (Generally: 65% ~ 75%); Transportation condition: Temperature Range: -35°C ~ 85°C , Humidity Range: 50% ~ 95% RH
- 12. Use components within 12 months. If 12 months or more have elapsed, check solderability before use.
- 13. Reflow profile recommend:

Lead-free heat endurance test

Lead-free the recommended reflow condition

